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#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	7KB (4K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	192 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	A/D 5x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16c73a-04i-sp">https://www.e-xfl.com/product-detail/microchip-technology/pic16c73a-04i-sp</a>

# PIC16C7X

**TABLE 3-3: PIC16C74/74A/77 PINOUT DESCRIPTION (Cont'd)**

Pin Name	DIP Pin#	PLCC Pin#	QFP Pin#	I/O/P Type	Buffer Type	Description
RC0/T1OSO/T1CKI	15	16	32	I/O	ST	<p>PORTC is a bi-directional I/O port.</p> <p>RC0 can also be the Timer1 oscillator output or a Timer1 clock input.</p> <p>RC1 can also be the Timer1 oscillator input or Capture2 input/Compare2 output/PWM2 output.</p> <p>RC2 can also be the Capture1 input/Compare1 output/PWM1 output.</p> <p>RC3 can also be the synchronous serial clock input/output for both SPI and I<sup>2</sup>C modes.</p> <p>RC4 can also be the SPI Data In (SPI mode) or data I/O (I<sup>2</sup>C mode).</p> <p>RC5 can also be the SPI Data Out (SPI mode).</p> <p>RC6 can also be the USART Asynchronous Transmit or Synchronous Clock.</p> <p>RC7 can also be the USART Asynchronous Receive or Synchronous Data.</p>
RC1/T1OSI/CCP2	16	18	35	I/O	ST	
RC2/CCP1	17	19	36	I/O	ST	
RC3/SCK/SCL	18	20	37	I/O	ST	
RC4/SDI/SDA	23	25	42	I/O	ST	
RC5/SDO	24	26	43	I/O	ST	
RC6/TX/CK	25	27	44	I/O	ST	
RC7/RX/DT	26	29	1	I/O	ST	
RD0/PSP0	19	21	38	I/O	ST/TTL <sup>(3)</sup>	<p>PORTD is a bi-directional I/O port or parallel slave port when interfacing to a microprocessor bus.</p>
RD1/PSP1	20	22	39	I/O	ST/TTL <sup>(3)</sup>	
RD2/PSP2	21	23	40	I/O	ST/TTL <sup>(3)</sup>	
RD3/PSP3	22	24	41	I/O	ST/TTL <sup>(3)</sup>	
RD4/PSP4	27	30	2	I/O	ST/TTL <sup>(3)</sup>	
RD5/PSP5	28	31	3	I/O	ST/TTL <sup>(3)</sup>	
RD6/PSP6	29	32	4	I/O	ST/TTL <sup>(3)</sup>	
RD7/PSP7	30	33	5	I/O	ST/TTL <sup>(3)</sup>	
RE0/RD $\bar{D}$ /AN5	8	9	25	I/O	ST/TTL <sup>(3)</sup>	<p>PORTE is a bi-directional I/O port.</p> <p>RE0 can also be read control for the parallel slave port, or analog input5.</p> <p>RE1 can also be write control for the parallel slave port, or analog input6.</p> <p>RE2 can also be select control for the parallel slave port, or analog input7.</p>
RE1/WR $\bar{R}$ /AN6	9	10	26	I/O	ST/TTL <sup>(3)</sup>	
RE2/CS $\bar{S}$ /AN7	10	11	27	I/O	ST/TTL <sup>(3)</sup>	
Vss	12,31	13,34	6,29	P	—	Ground reference for logic and I/O pins.
VDD	11,32	12,35	7,28	P	—	Positive supply for logic and I/O pins.
NC	—	1,17,28,40	12,13,33,34		—	These pins are not internally connected. These pins should be left unconnected.

Legend: I = input      O = output      I/O = input/output      P = power  
 — = Not used      TTL = TTL input      ST = Schmitt Trigger input

- Note 1: This buffer is a Schmitt Trigger input when configured as an external interrupt.  
 2: This buffer is a Schmitt Trigger input when used in serial programming mode.  
 3: This buffer is a Schmitt Trigger input when configured as general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).  
 4: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.

## 5.5 PORTE and TRISE Register

### Applicable Devices

72	73	73A	74	74A	76	77
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PORTE has three pins RE0/ $\overline{\text{RD}}$ /AN5, RE1/ $\overline{\text{WR}}$ /AN6 and RE2/ $\overline{\text{CS}}$ /AN7, which are individually configurable as inputs or outputs. These pins have Schmitt Trigger input buffers.

I/O PORTE becomes control inputs for the microprocessor port when bit PSPMODE (TRISE<4>) is set. In this mode, the user must make sure that the TRISE<2:0> bits are set (pins are configured as digital inputs) and that register ADCON1 is configured for digital I/O. In this mode the input buffers are TTL.

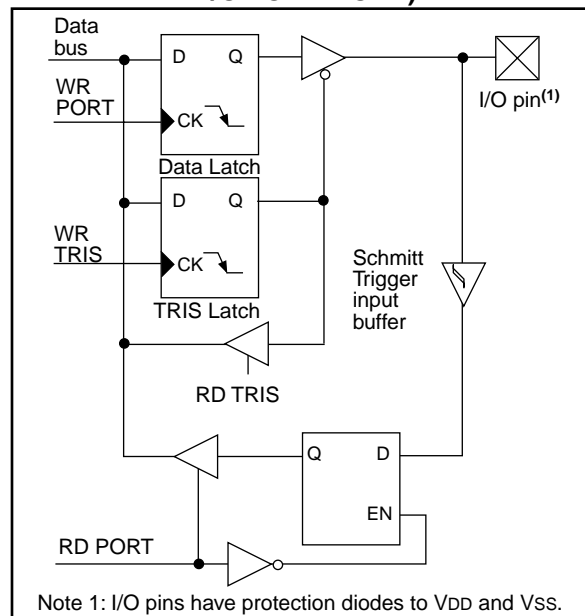
Figure 5-9 shows the TRISE register, which also controls the parallel slave port operation.

ORTE pins are multiplexed with analog inputs. The operation of these pins is selected by control bits in the ADCON1 register. When selected as an analog input, these pins will read as '0's.

TRISE controls the direction of the RE pins, even when they are being used as analog inputs. The user must make sure to keep the pins configured as inputs when using them as analog inputs.

**Note:** On a Power-on Reset these pins are configured as analog inputs.

**FIGURE 5-8: PORTE BLOCK DIAGRAM (IN I/O PORT MODE)**



**FIGURE 5-9: TRISE REGISTER (ADDRESS 89h)**

R-0	R-0	R/W-0	R/W-0	U-0	R/W-1	R/W-1	R/W-1
IBF	OBF	IBOV	PSPMODE	—	bit2	bit1	bit0

bit7

- R = Readable bit
- W = Writable bit
- U = Unimplemented bit, read as '0'
- n = Value at POR reset

- bit 7 : **IBF**: Input Buffer Full Status bit  
1 = A word has been received and is waiting to be read by the CPU  
0 = No word has been received
- bit 6: **OBF**: Output Buffer Full Status bit  
1 = The output buffer still holds a previously written word  
0 = The output buffer has been read
- bit 5: **IBOV**: Input Buffer Overflow Detect bit (in microprocessor mode)  
1 = A write occurred when a previously input word has not been read (must be cleared in software)  
0 = No overflow occurred
- bit 4: **PSPMODE**: Parallel Slave Port Mode Select bit  
1 = Parallel slave port mode  
0 = General purpose I/O mode
- bit 3: **Unimplemented**: Read as '0'
- ### PORTC Data Direction Bits
- bit 2: **Bit2**: Direction Control bit for pin RE2/ $\overline{CS}$ /AN7  
1 = Input  
0 = Output
- bit 1: **Bit1**: Direction Control bit for pin RE1/ $\overline{WR}$ /AN6  
1 = Input  
0 = Output
- bit 0: **Bit0**: Direction Control bit for pin RE0/ $\overline{RD}$ /AN5  
1 = Input  
0 = Output

**FIGURE 11-2: SSPCON: SYNC SERIAL PORT CONTROL REGISTER (ADDRESS 14h)**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0
bit7							bit0

R = Readable bit  
W = Writable bit  
U = Unimplemented bit, read as '0'  
- n = Value at POR reset

bit 7: **WCOL**: Write Collision Detect bit  
1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software)  
0 = No collision

bit 6: **SSPOV**: Receive Overflow Detect bit  
In SPI mode  
1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of overflow, the data in SSPSR register is lost. Overflow can only occur in slave mode. The user must read the SSPBUF, even if only transmitting data, to avoid setting overflow. In master mode the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register.  
0 = No overflow  
In I<sup>2</sup>C mode  
1 = A byte is received while the SSPBUF register is still holding the previous byte. SSPOV is a "don't care" in transmit mode. SSPOV must be cleared in software in either mode.  
0 = No overflow

bit 5: **SSPEN**: Synchronous Serial Port Enable bit  
In SPI mode  
1 = Enables serial port and configures SCK, SDO, and SDI as serial port pins  
0 = Disables serial port and configures these pins as I/O port pins  
In I<sup>2</sup>C mode  
1 = Enables the serial port and configures the SDA and SCL pins as serial port pins  
0 = Disables serial port and configures these pins as I/O port pins  
In both modes, when enabled, these pins must be properly configured as input or output.

bit 4: **CKP**: Clock Polarity Select bit  
In SPI mode  
1 = Idle state for clock is a high level. Transmit happens on falling edge, receive on rising edge.  
0 = Idle state for clock is a low level. Transmit happens on rising edge, receive on falling edge.  
In I<sup>2</sup>C mode  
SCK release control  
1 = Enable clock  
0 = Holds clock low (clock stretch) (Used to ensure data setup time)

bit 3-0: **SSPM3:SSPM0**: Synchronous Serial Port Mode Select bits  
0000 = SPI master mode, clock = Fosc/4  
0001 = SPI master mode, clock = Fosc/16  
0010 = SPI master mode, clock = Fosc/64  
0011 = SPI master mode, clock = TMR2 output/2  
0100 = SPI slave mode, clock = SCK pin.  $\overline{SS}$  pin control enabled.  
0101 = SPI slave mode, clock = SCK pin.  $\overline{SS}$  pin control disabled.  $\overline{SS}$  can be used as I/O pin.  
0110 = I<sup>2</sup>C slave mode, 7-bit address  
0111 = I<sup>2</sup>C slave mode, 10-bit address  
1011 = I<sup>2</sup>C firmware controlled Master Mode (slave idle)  
1110 = I<sup>2</sup>C slave mode, 7-bit address with start and stop bit interrupts enabled  
1111 = I<sup>2</sup>C slave mode, 10-bit address with start and stop bit interrupts enabled

To enable the serial port, SSP Enable bit, SSPEN (SSPCON<5>) must be set. To reset or reconfigure SPI mode, clear bit SSPEN, re-initialize the SSPCON register, and then set bit SSPEN. This configures the SDI, SDO, SCK, and  $\overline{SS}$  pins as serial port pins. For the pins to behave as the serial port function, they must have their data direction bits (in the TRISC register) appropriately programmed. That is:

- SDI must have TRISC<4> set
- SDO must have TRISC<5> cleared
- SCK (Master mode) must have TRISC<3> cleared
- SCK (Slave mode) must have TRISC<3> set
- $\overline{SS}$  must have TRISA<5> set

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value. An example would be in master mode where you are only sending data (to a display driver), then both SDI and  $\overline{SS}$  could be used as general purpose outputs by clearing their corresponding TRIS register bits.

Figure 11-10 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge, and latched on the opposite edge of the clock. Both processors should be programmed to same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application firmware. This leads to three scenarios for data transmission:

- Master sends data — Slave sends dummy data
- Master sends data — Slave sends data
- Master sends dummy data — Slave sends data

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2) is to broadcast data by the firmware protocol.

In master mode the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SCK output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a “line activity monitor” mode.

In slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched the interrupt flag bit SSPIF (PIR1<3>) is set.

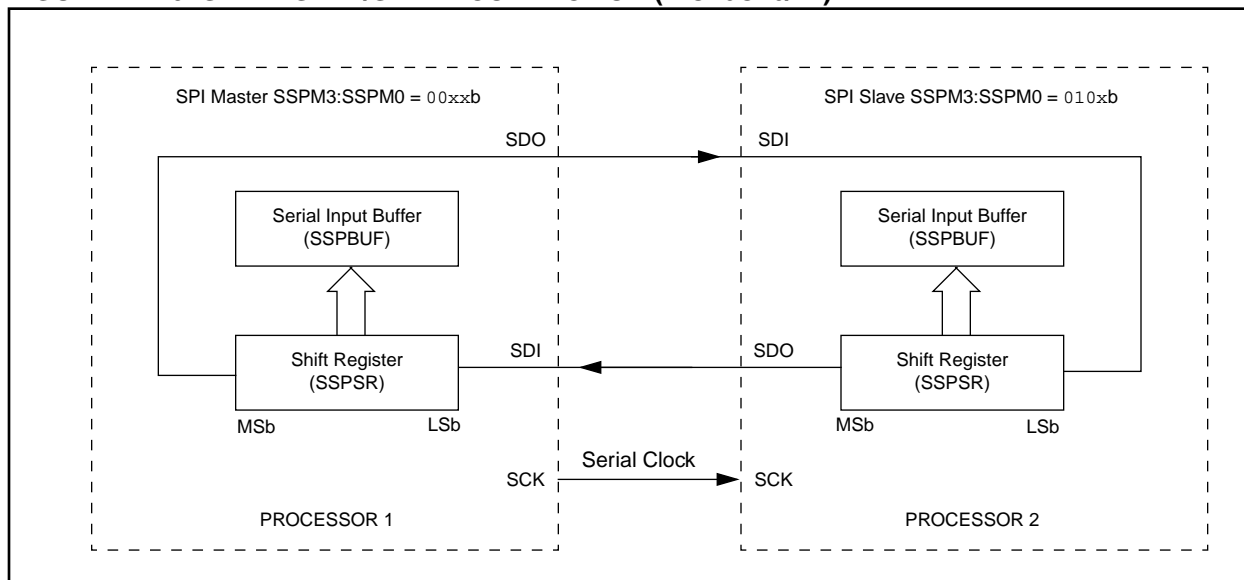
The clock polarity is selected by appropriately programming bit CKP (SSPCON<4>). This then would give waveforms for SPI communication as shown in Figure 11-11, Figure 11-12, and Figure 11-13 where the MSB is transmitted first. In master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- $F_{osc}/4$  (or  $T_{cy}$ )
- $F_{osc}/16$  (or  $4 \cdot T_{cy}$ )
- $F_{osc}/64$  (or  $16 \cdot T_{cy}$ )
- Timer2 output/2

This allows a maximum bit clock frequency (at 20 MHz) of 5 MHz. When in slave mode the external clock must meet the minimum high and low times.

In sleep mode, the slave can transmit and receive data and wake the device from sleep.

**FIGURE 11-10: SPI MASTER/SLAVE CONNECTION (PIC16C76/77)**



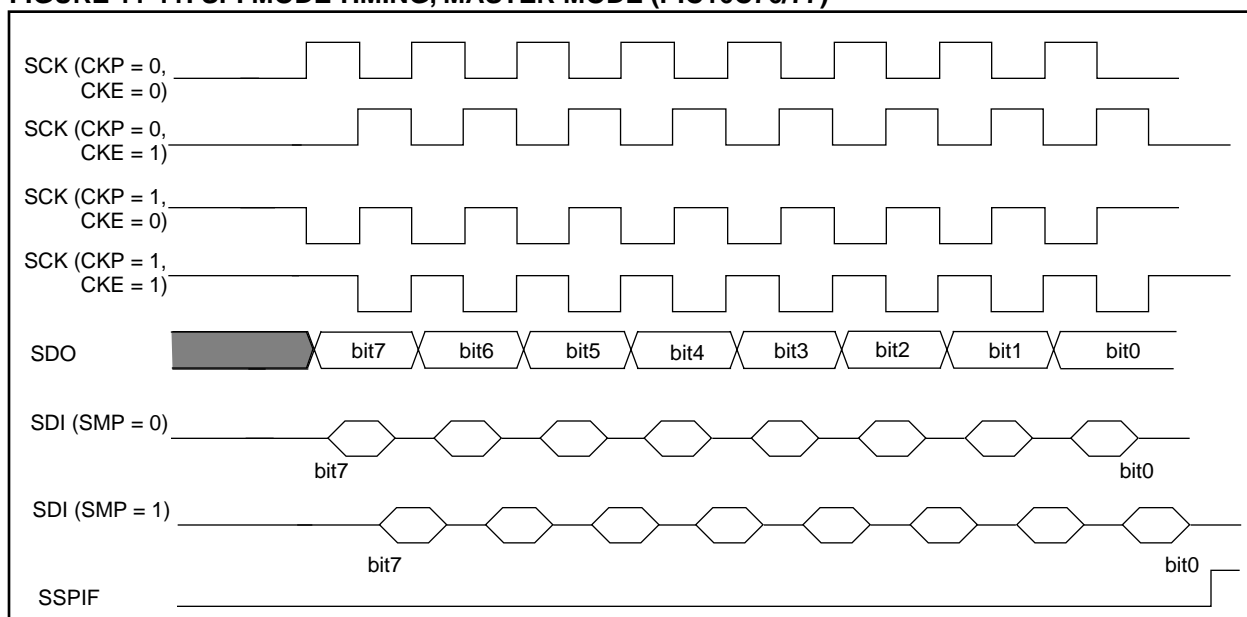
The  $\overline{SS}$  pin allows a synchronous slave mode. The SPI must be in slave mode (SSPCON<3:0> = 04h) and the TRISA<5> bit must be set for the synchronous slave mode to be enabled. When the  $\overline{SS}$  pin is low, transmission and reception are enabled and the SDO pin is driven. When the  $\overline{SS}$  pin goes high, the SDO pin is no longer driven, even if in the middle of a transmitted byte, and becomes a floating output. If the  $\overline{SS}$  pin is taken low without resetting SPI mode, the transmission will continue from the point at which it was taken high. External pull-up/pull-down resistors may be desirable, depending on the application.

**Note:** When the SPI is in Slave Mode with  $\overline{SS}$  pin control enabled, (SSPCON<3:0> = 0100) the SPI module will reset if the  $\overline{SS}$  pin is set to VDD.

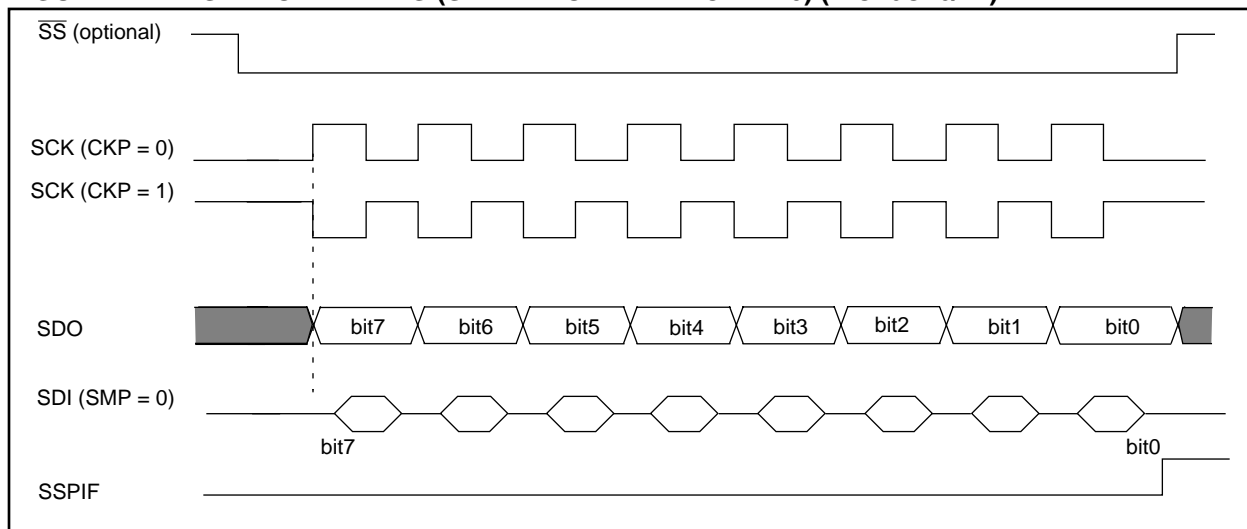
**Note:** If the SPI is used in Slave Mode with CKE = '1', then the  $\overline{SS}$  pin control must be enabled.

To emulate two-wire communication, the SDO pin can be connected to the SDI pin. When the SPI needs to operate as a receiver the SDO pin can be configured as an input. This disables transmissions from the SDO. The SDI can always be left as an input (SDI function) since it cannot create a bus conflict.

**FIGURE 11-11: SPI MODE TIMING, MASTER MODE (PIC16C76/77)**



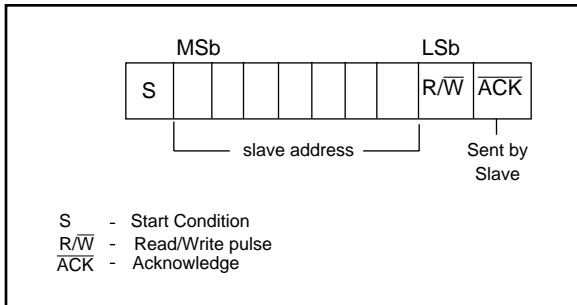
**FIGURE 11-12: SPI MODE TIMING (SLAVE MODE WITH CKE = 0) (PIC16C76/77)**



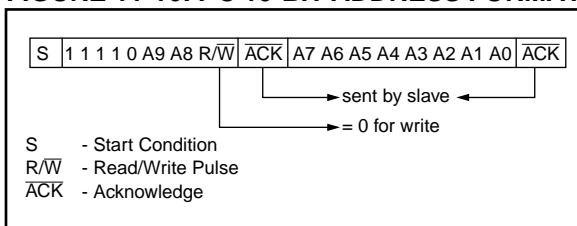
## 11.4.2 ADDRESSING I<sup>2</sup>C DEVICES

There are two address formats. The simplest is the 7-bit address format with a R/W bit (Figure 11-15). The more complex is the 10-bit address with a R/W bit (Figure 11-16). For 10-bit address format, two bytes must be transmitted with the first five bits specifying this to be a 10-bit address.

**FIGURE 11-15: 7-BIT ADDRESS FORMAT**



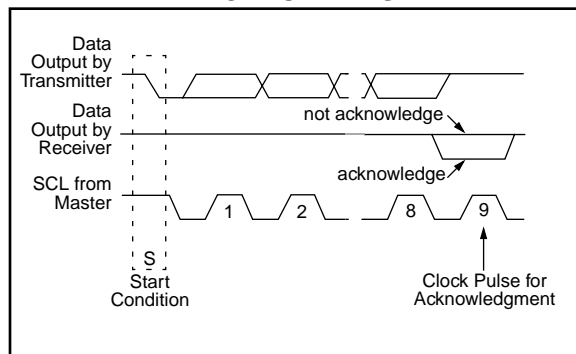
**FIGURE 11-16: I<sup>2</sup>C 10-BIT ADDRESS FORMAT**



## 11.4.3 TRANSFER ACKNOWLEDGE

All data must be transmitted per byte, with no limit to the number of bytes transmitted per data transfer. After each byte, the slave-receiver generates an acknowledge bit ( $\overline{ACK}$ ) (Figure 11-17). When a slave-receiver doesn't acknowledge the slave address or received data, the master must abort the transfer. The slave must leave SDA high so that the master can generate the STOP condition (Figure 11-14).

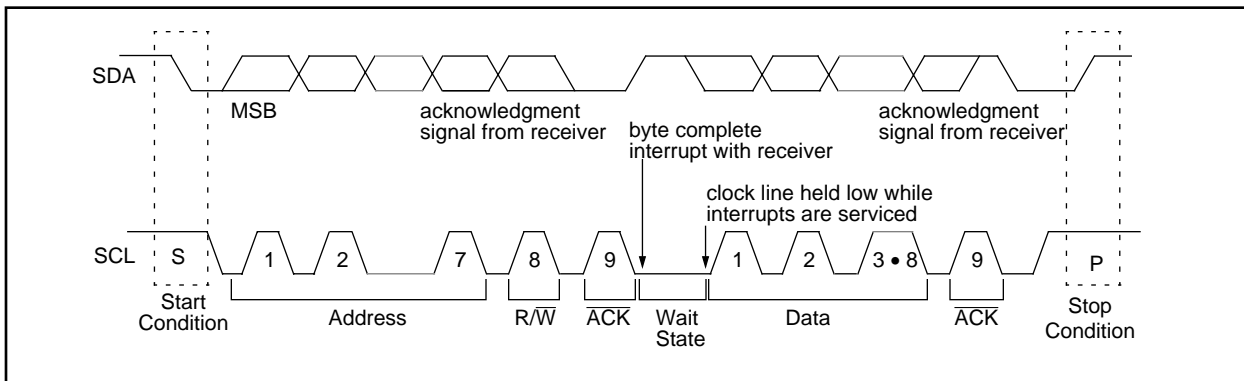
**FIGURE 11-17: SLAVE-RECEIVER ACKNOWLEDGE**



If the master is receiving the data (master-receiver), it generates an acknowledge signal for each received byte of data, except for the last byte. To signal the end of data to the slave-transmitter, the master does not generate an acknowledge (not acknowledge). The slave then releases the SDA line so the master can generate the STOP condition. The master can also generate the STOP condition during the acknowledge pulse for valid termination of data transfer.

If the slave needs to delay the transmission of the next byte, holding the SCL line low will force the master into a wait state. Data transfer continues when the slave releases the SCL line. This allows the slave to move the received data or fetch the data it needs to transfer before allowing the clock to start. This wait state technique can also be implemented at the bit level, Figure 11-18. The slave will inherently stretch the clock, when it is a transmitter, but will not when it is a receiver. The slave will have to clear the SSPCON<4> bit to enable clock stretching when it is a receiver.

**FIGURE 11-18: DATA TRANSFER WAIT STATE**



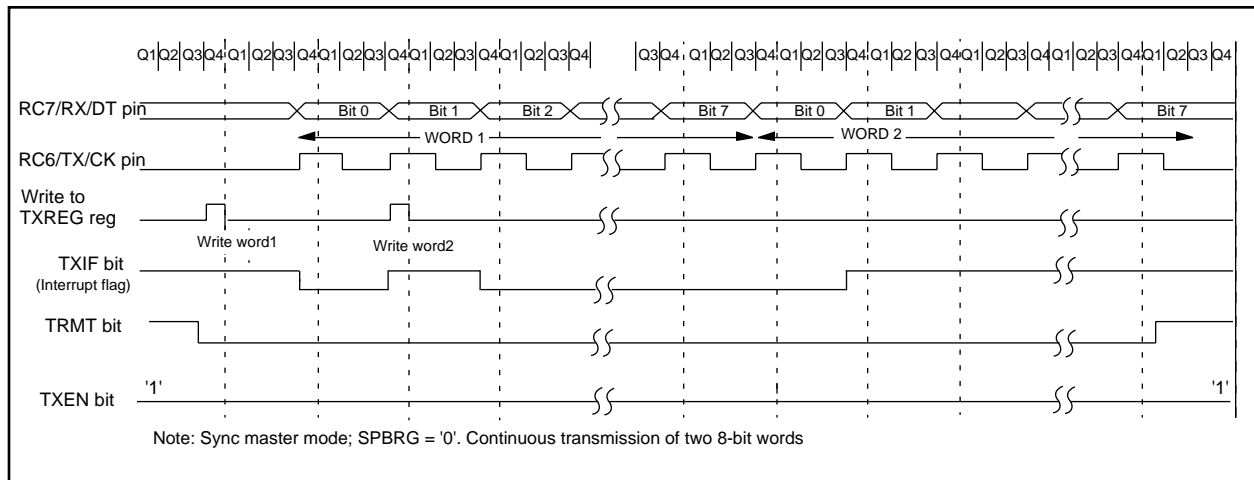
**TABLE 12-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION**

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF <sup>(1)</sup>	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Transmit Register								0000 0000	0000 0000
8Ch	PIE1	PSPIE <sup>(1)</sup>	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate Generator Register								0000 0000	0000 0000

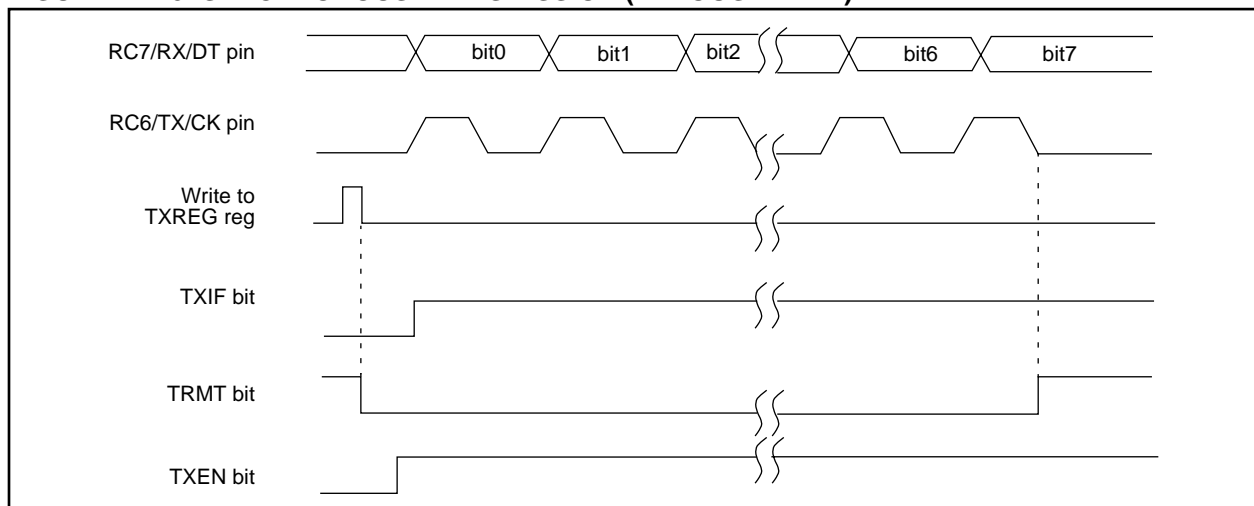
Legend: x = unknown, - = unimplemented, read as '0'. Shaded cells are not used for Synchronous Master Transmission.

Note 1: Bits PSPIE and PSPIF are reserved on the PIC16C73/73A/76, always maintain these bits clear.

**FIGURE 12-12: SYNCHRONOUS TRANSMISSION**



**FIGURE 12-13: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)**





# PIC16C7X

## 13.1 A/D Acquisition Requirements

Applicable Devices							
72	73	73A	74	74A	76	77	

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 13-4. The source impedance (RS) and the internal sampling switch (RSS) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (RSS) impedance varies over the device voltage (VDD), Figure 13-4. The source impedance affects the offset voltage at the analog input (due to pin leakage current). **The maximum recommended impedance for analog sources is 10 kΩ.** After the analog input channel is selected (changed) this acquisition must be done before the conversion can be started.

To calculate the minimum acquisition time, Equation 13-1 may be used. This equation calculates the acquisition time to within 1/2 LSB error is used (512 steps for the A/D). The 1/2 LSB error is the maximum error allowed for the A/D to meet its specified accuracy.

### EQUATION 13-1: A/D MINIMUM CHARGING TIME

$$V_{HOLD} = (V_{REF} - (V_{REF}/512)) \cdot (1 - e^{-(T_{CAP}/CHOLD)(R_{IC} + R_{SS} + R_S)})$$

Given:  $V_{HOLD} = (V_{REF}/512)$ , for 1/2 LSB resolution

The above equation reduces to:

$$T_{CAP} = -(51.2 \text{ pF})(1 \text{ k}\Omega + R_{SS} + R_S) \ln(1/511)$$

Example 13-1 shows the calculation of the minimum required acquisition time TACQ. This calculation is based on the following system assumptions.

CHOLD = 51.2 pF

RS = 10 kΩ

1/2 LSB error

VDD = 5V → RSS = 7 kΩ

Temp (application system max.) = 50°C

VHOLD = 0 @ t = 0

**Note 1:** The reference voltage (VREF) has no effect on the equation, since it cancels itself out.

**Note 2:** The charge holding capacitor (CHOLD) is not discharged after each conversion.

**Note 3:** The maximum recommended impedance for analog sources is 10 kΩ. This is required to meet the pin leakage specification.

**Note 4:** After a conversion has completed, a 2.0TAD delay must complete before acquisition can begin again. During this time the holding capacitor is not connected to the selected A/D input channel.

### EXAMPLE 13-1: CALCULATING THE MINIMUM REQUIRED ACQUISITION TIME

TACQ = Amplifier Settling Time +  
Holding Capacitor Charging Time +  
Temperature Coefficient

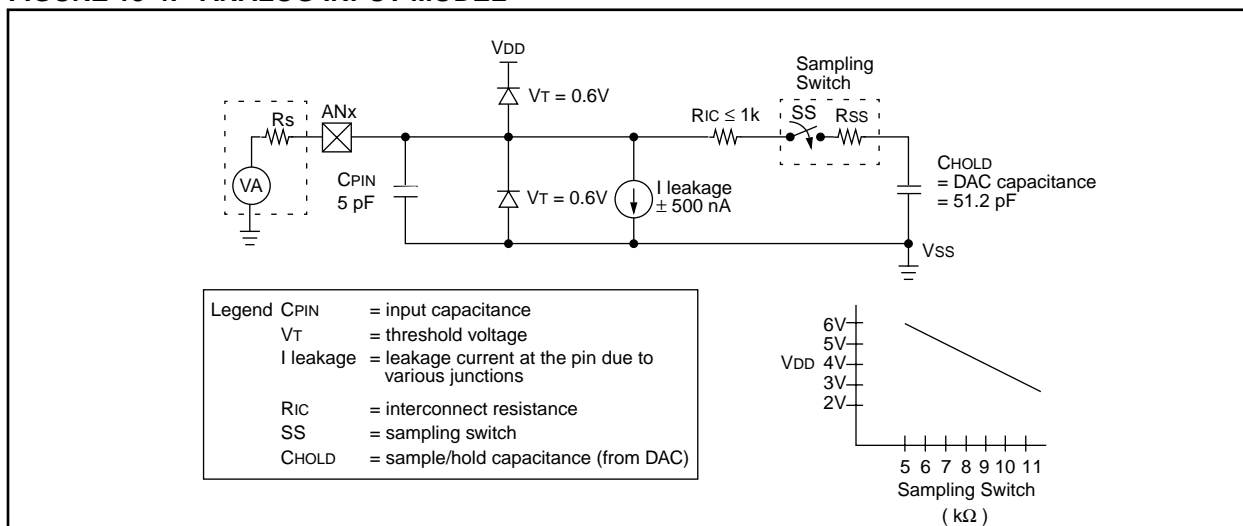
$$T_{ACQ} = 5 \mu\text{s} + T_{CAP} + [(Temp - 25^\circ\text{C})(0.05 \mu\text{s}/^\circ\text{C})]$$

$$\begin{aligned} T_{CAP} &= -CHOLD (R_{IC} + R_{SS} + R_S) \ln(1/511) \\ &= -51.2 \text{ pF} (1 \text{ k}\Omega + 7 \text{ k}\Omega + 10 \text{ k}\Omega) \ln(0.0020) \\ &= -51.2 \text{ pF} (18 \text{ k}\Omega) \ln(0.0020) \\ &= -0.921 \mu\text{s} (-6.2364) \end{aligned}$$

$$5.747 \mu\text{s}$$

$$\begin{aligned} T_{ACQ} &= 5 \mu\text{s} + 5.747 \mu\text{s} + [(50^\circ\text{C} - 25^\circ\text{C})(0.05 \mu\text{s}/^\circ\text{C})] \\ &= 10.747 \mu\text{s} + 1.25 \mu\text{s} \\ &= 11.997 \mu\text{s} \end{aligned}$$

FIGURE 13-4: ANALOG INPUT MODEL



## 14.4.5 TIME-OUT SEQUENCE

On power-up the time-out sequence is as follows: First PWRT time-out is invoked after the POR time delay has expired. Then OST is activated. The total time-out will vary based on oscillator configuration and the status of the PWRT. For example, in RC mode with the PWRT disabled, there will be no time-out at all. Figure 14-10, Figure 14-11, and Figure 14-12 depict time-out sequences on power-up.

Since the time-outs occur from the POR pulse, if  $\overline{\text{MCLR}}$  is kept low long enough, the time-outs will expire. Then bringing MCLR high will begin execution immediately (Figure 14-11). This is useful for testing purposes or to synchronize more than one PIC16CXX device operating in parallel.

Table 14-7 shows the reset conditions for some special function registers, while Table 14-8 shows the reset conditions for all the registers.

## 14.4.6 POWER CONTROL/STATUS REGISTER (PCON)

Applicable Devices					
72	73	73A	74	74A	76/77

The Power Control/Status Register, PCON has up to two bits, depending upon the device. Bit0 is not implemented on the PIC16C73 or PIC16C74.

Bit0 is Brown-out Reset Status bit,  $\overline{\text{BOR}}$ . Bit  $\overline{\text{BOR}}$  is unknown on a Power-on Reset. It must then be set by the user and checked on subsequent resets to see if bit  $\overline{\text{BOR}}$  cleared, indicating a BOR occurred. The  $\overline{\text{BOR}}$  bit is a "Don't Care" bit and is not necessarily predictable if the Brown-out Reset circuitry is disabled (by clearing bit BODEN in the Configuration Word).

Bit1 is  $\overline{\text{POR}}$  (Power-on Reset Status bit). It is cleared on a Power-on Reset and unaffected otherwise. The user must set this bit following a Power-on Reset.

**TABLE 14-3: TIME-OUT IN VARIOUS SITUATIONS, PIC16C73/74**

Oscillator Configuration	Power-up		Wake-up from SLEEP
	PWRTE = 1	PWRTE = 0	
XT, HS, LP	72 ms + 1024Tosc	1024Tosc	1024Tosc
RC	72 ms	—	—

**TABLE 14-4: TIME-OUT IN VARIOUS SITUATIONS, PIC16C72/73A/74A/76/77**

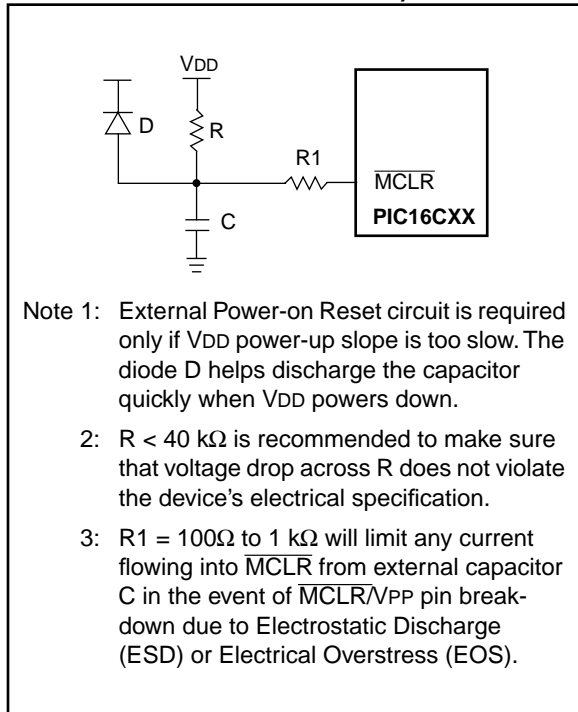
Oscillator Configuration	Power-up		Brown-out	Wake-up from SLEEP
	PWRTE = 0	PWRTE = 1		
XT, HS, LP	72 ms + 1024Tosc	1024Tosc	72 ms + 1024Tosc	1024Tosc
RC	72 ms	—	72 ms	—

**TABLE 14-5: STATUS BITS AND THEIR SIGNIFICANCE, PIC16C73/74**

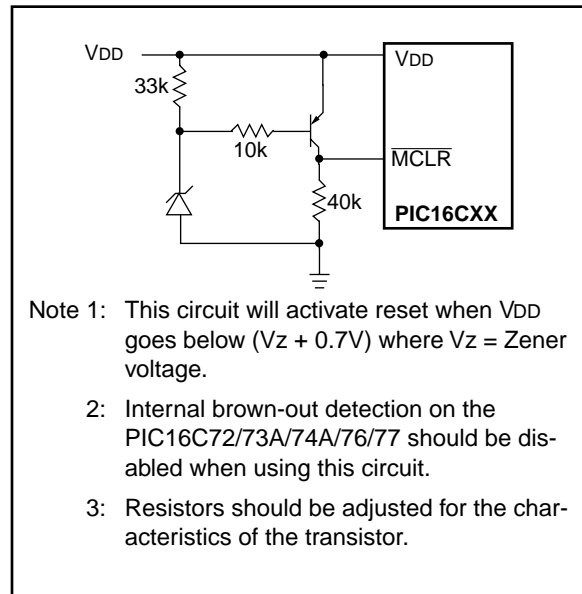
POR	$\overline{\text{TO}}$	$\overline{\text{PD}}$	
0	1	1	Power-on Reset
0	0	x	Illegal, $\overline{\text{TO}}$ is set on $\overline{\text{POR}}$
0	x	0	Illegal, $\overline{\text{PD}}$ is set on $\overline{\text{POR}}$
1	0	1	WDT Reset
1	0	0	WDT Wake-up
1	u	u	MCLR Reset during normal operation
1	1	0	MCLR Reset during SLEEP or interrupt wake-up from SLEEP

Legend: u = unchanged, x = unknown

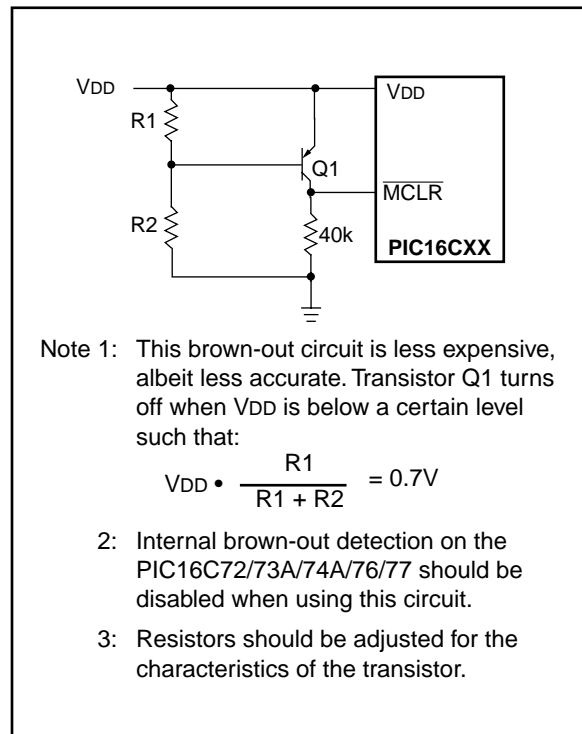
**FIGURE 14-13: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)**



**FIGURE 14-14: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1**



**FIGURE 14-15: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2**



# PIC16C7X

## IORWF Inclusive OR W with f

Syntax:	[ <i>label</i> ] IORWF f,d			
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$			
Operation:	(W) .OR. (f) → (destination)			
Status Affected:	Z			
Encoding:	00	0100	dfff	ffff
Description:	Inclusive OR the W register with register 'f'. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination

Example IORWF RESULT, 0

Before Instruction

RESULT = 0x13  
W = 0x91

After Instruction

RESULT = 0x13  
W = 0x93  
Z = 1

## MOVF Move f

Syntax:	[ <i>label</i> ] MOVF f,d			
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$			
Operation:	(f) → (destination)			
Status Affected:	Z			
Encoding:	00	1000	dfff	ffff
Description:	The contents of register f is moved to a destination dependant upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination

Example MOVF FSR, 0

After Instruction

W = value in FSR register  
Z = 1

## MOVLW Move Literal to W

Syntax:	[ <i>label</i> ] MOVLW k			
Operands:	$0 \leq k \leq 255$			
Operation:	$k \rightarrow (W)$			
Status Affected:	None			
Encoding:	11	00xx	kkkk	kkkk
Description:	The eight bit literal 'k' is loaded into W register. The don't cares will assemble as 0's.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read literal 'k'	Process data	Write to W

Example

MOVLW 0x5A

After Instruction

W = 0x5A

## MOVWF Move W to f

Syntax:	[ <i>label</i> ] MOVWF f			
Operands:	$0 \leq f \leq 127$			
Operation:	(W) → (f)			
Status Affected:	None			
Encoding:	00	0000	1fff	ffff
Description:	Move data from W register to register 'f'.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write register 'f'

Example

MOVWF OPTION\_REG

Before Instruction

OPTION = 0xFF  
W = 0x4F

After Instruction

OPTION = 0x4F  
W = 0x4F

# PIC16C7X

Applicable Devices 72 73 73A 74 74A 76 77

## 17.4 Timing Parameter Symbolology

The timing parameter symbols have been created following one of the following formats:

1. TppS2ppS
2. TppS
3. TCC:ST (I<sup>2</sup>C specifications only)
4. Ts (I<sup>2</sup>C specifications only)

T		T	
F	Frequency	T	Time

Lowercase letters (pp) and their meanings:

pp			
cc	CCP1	osc	OSC1
ck	CLKOUT	rd	$\overline{RD}$
cs	$\overline{CS}$	rw	$\overline{RD}$ or $\overline{WR}$
di	SDI	sc	SCK
do	SDO	ss	$\overline{SS}$
dt	Data in	t0	T0CKI
io	I/O port	t1	T1CKI
mc	$\overline{MCLR}$	wr	$\overline{WR}$

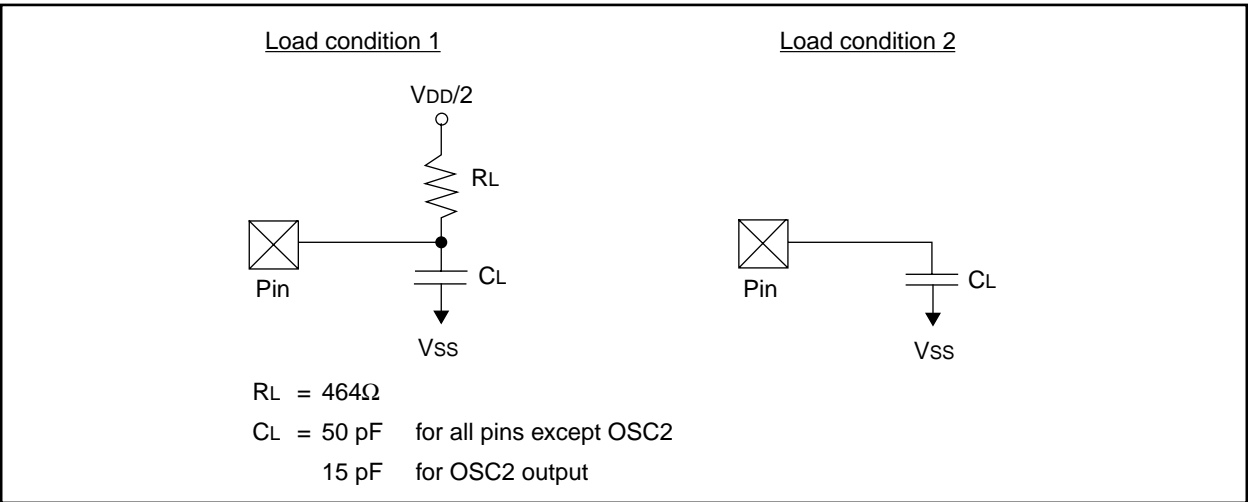
Uppercase letters and their meanings:

S			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I <sup>2</sup> C only		High	High
AA	output access	Low	Low
BUF	Bus free		

TCC:ST (I<sup>2</sup>C specifications only)

CC			
HD	Hold	SU	Setup
ST		STO	STOP condition
DAT	DATA input hold		
STA	START condition		

FIGURE 17-1: LOAD CONDITIONS



Applicable Devices	72	73	73A	74	74A	76	77
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## 18.0 ELECTRICAL CHARACTERISTICS FOR PIC16C73/74

### Absolute Maximum Ratings †

Ambient temperature under bias .....	-55 to +125°C
Storage temperature .....	-65°C to +150°C
Voltage on any pin with respect to VSS (except VDD, $\overline{\text{MCLR}}$ , and RA4) .....	-0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS .....	-0.3 to +7.5V
Voltage on $\overline{\text{MCLR}}$ with respect to VSS (Note 2) .....	0 to +14V
Voltage on RA4 with respect to VSS .....	0 to +14V
Total power dissipation (Note 1) .....	1.0W
Maximum current out of VSS pin .....	300 mA
Maximum current into VDD pin .....	250 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > VDD) .....	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > VDD) .....	±20 mA
Maximum output current sunk by any I/O pin .....	25 mA
Maximum output current sourced by any I/O pin .....	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (combined) (Note 3) .....	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (combined) (Note 3) .....	200 mA
Maximum current sunk by PORTC and PORTD (combined) (Note 3) .....	200 mA
Maximum current sourced by PORTC and PORTD (combined) (Note 3) .....	200 mA

**Note 1:** Power dissipation is calculated as follows:  $P_{dis} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$

**Note 2:** Voltage spikes below VSS at the  $\overline{\text{MCLR}}$  pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a “low” level to the  $\overline{\text{MCLR}}$  pin rather than pulling this pin directly to VSS.

**Note 3:** PORTD and PORTE are not implemented on the PIC16C73.

† NOTICE: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**TABLE 18-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)**

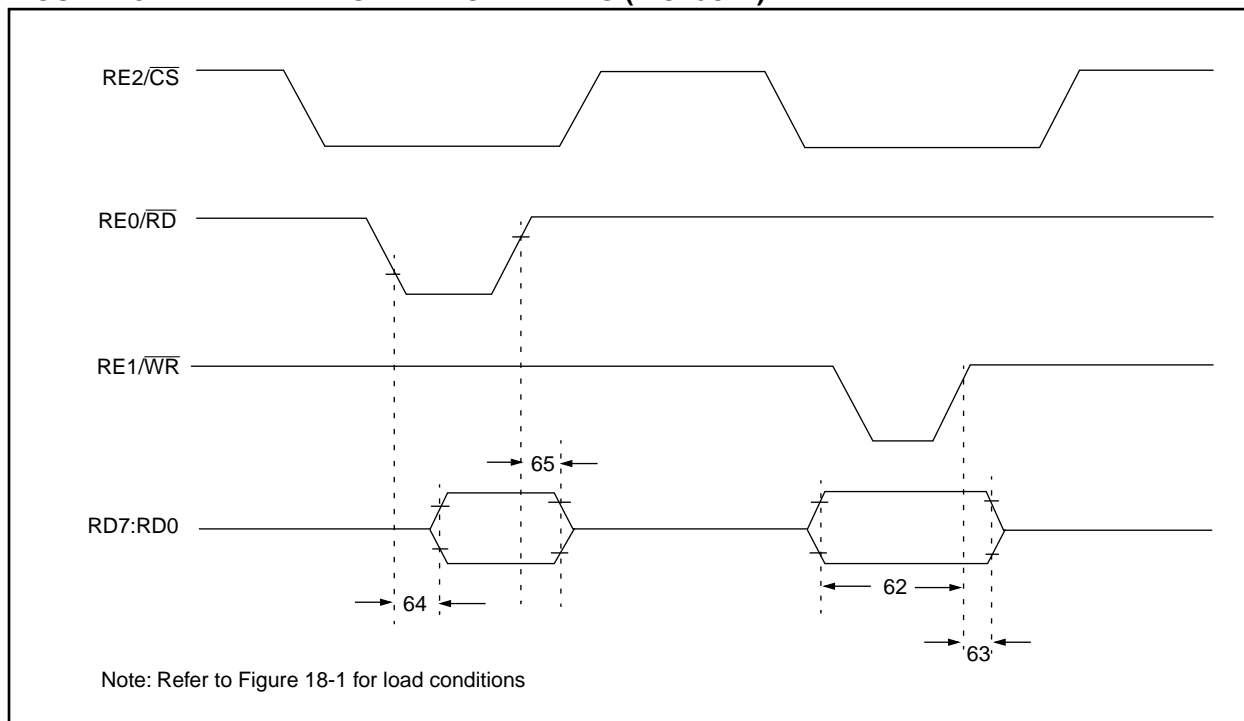
OSC	PIC16C73-04 PIC16C74-04	PIC16C73-10 PIC16C74-10	PIC16C73-20 PIC16C74-20	PIC16LC73-04 PIC16LC74-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 13.5 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 13.5 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 15 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 10 MHz max.	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 µA typ. at 32 kHz, 4.0V IPD: 0.9 µA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 3.0V to 6.0V IDD: 48 µA max. at 32 kHz, 3.0V IPD: 13.5 µA max. at 3.0V Freq: 200 kHz max.	VDD: 3.0V to 6.0V IDD: 48 µA max. at 32 kHz, 3.0V IPD: 13.5 µA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

# PIC16C7X

Applicable Devices 72 73 73A 74 74A 76 77

**FIGURE 18-7: PARALLEL SLAVE PORT TIMING (PIC16C74)**



**TABLE 18-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C74)**

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
62	TdtV2wrH	Data in valid before $\overline{WR}\uparrow$ or $\overline{CS}\uparrow$ (setup time)	20	—	—	ns	
63*	TwrH2dtI	$\overline{WR}\uparrow$ or $\overline{CS}\uparrow$ to data-in invalid (hold time)	PIC16C74	20	—	ns	
			PIC16LC74	35	—	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data-out valid	—	—	80	ns	
65	TrdH2dtI	$\overline{RD}\uparrow$ or $\overline{CS}\downarrow$ to data-out invalid	10	—	30	ns	

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

## 19.0 ELECTRICAL CHARACTERISTICS FOR PIC16C73A/74A

### Absolute Maximum Ratings †

Ambient temperature under bias	-55 to +125°C
Storage temperature	-65°C to +150°C
Voltage on any pin with respect to VSS (except VDD, $\overline{\text{MCLR}}$ , and RA4)	-0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS	-0.3 to +7.5V
Voltage on $\overline{\text{MCLR}}$ with respect to VSS (Note 2)	0 to +14V
Voltage on RA4 with respect to VSS	0 to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of VSS pin	300 mA
Maximum current into VDD pin	250 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > VDD)	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (combined) (Note 3)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (combined) (Note 3)	200 mA
Maximum current sunk by PORTC and PORTD (combined) (Note 3)	200 mA
Maximum current sourced by PORTC and PORTD (combined) (Note 3)	200 mA

**Note 1:** Power dissipation is calculated as follows:  $P_{dis} = V_{DD} \times I_{DD} - \sum I_{OH} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$

**Note 2:** Voltage spikes below VSS at the  $\overline{\text{MCLR}}$  pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a “low” level to the  $\overline{\text{MCLR}}$  pin rather than pulling this pin directly to VSS.

**Note 3:** PORTD and PORTE are not implemented on the PIC16C73A.

† NOTICE: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**TABLE 19-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)**

OSC	PIC16C73A-04 PIC16C74A-04	PIC16C73A-10 PIC16C74A-10	PIC16C73A-20 PIC16C74A-20	PIC16LC73A-04 PIC16LC74A-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 5 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 5 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 10 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 10 MHz max.	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 µA typ. at 32 kHz, 4.0V IPD: 0.9 µA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 2.5V to 6.0V IDD: 48 µA max. at 32 kHz, 3.0V IPD: 5.0 µA max. at 3.0V Freq: 200 kHz max.	VDD: 2.5V to 6.0V IDD: 48 µA max. at 32 kHz, 3.0V IPD: 5.0 µA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.



# PIC16C7X

Applicable Devices 72 73 73A 74 74A 76 77

**19.3 DC Characteristics:** **PIC16C73A/74A-04 (Commercial, Industrial, Extended)**  
**PIC16C73A/74A-10 (Commercial, Industrial, Extended)**  
**PIC16C73A/74A-20 (Commercial, Industrial, Extended)**  
**PIC16LC73A/74A-04 (Commercial, Industrial)**

<b>Standard Operating Conditions (unless otherwise stated)</b> Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended, $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial Operating voltage VDD range as described in DC spec Section 19.1 and Section 19.2.							
Param No.	Characteristic	Sym	Min	Typ †	Max	Units	Conditions
D030 D030A D031 D032 D033	<b>Input Low Voltage</b> I/O ports with TTL buffer with Schmitt Trigger buffer MCLR, OSC1 (in RC mode) OSC1 (in XT, HS and LP)	V <sub>IL</sub>	V <sub>SS</sub> V <sub>SS</sub> V <sub>SS</sub> V <sub>SS</sub> V <sub>SS</sub>	- - - - -	0.15V <sub>DD</sub> 0.8V 0.2V <sub>DD</sub> 0.2V <sub>DD</sub> 0.3V <sub>DD</sub>	V V V V V	For entire VDD range 4.5V ≤ VDD ≤ 5.5V  Note1
D040 D040A  D041 D042 D042A D043	<b>Input High Voltage</b> I/O ports with TTL buffer  with Schmitt Trigger buffer MCLR OSC1 (XT, HS and LP) OSC1 (in RC mode)	V <sub>IH</sub>	2.0 0.25V <sub>DD</sub> + 0.8V  0.8V <sub>DD</sub> 0.8V <sub>DD</sub> 0.7V <sub>DD</sub> 0.9V <sub>DD</sub>	- - - - - - -	V <sub>DD</sub> V <sub>DD</sub>  V <sub>DD</sub> V <sub>DD</sub> V <sub>DD</sub> V <sub>DD</sub>	V V  V V V V	4.5V ≤ VDD ≤ 5.5V For entire VDD range  For entire VDD range  Note1
D070	PORTB weak pull-up current	IPURB	50	250	400	μA	VDD = 5V, VPIN = VSS
D060  D061 D063	<b>Input Leakage Current</b> (Notes 2, 3) I/O ports  MCLR, RA4/T0CKI OSC1	I <sub>IL</sub>	-  - -	-  - -	±1  ±5 ±5	μA  μA μA	VSS ≤ VPIN ≤ VDD, Pin at hi-impedance VSS ≤ VPIN ≤ VDD VSS ≤ VPIN ≤ VDD, XT, HS and LP osc configuration
D080 D080A D083 D083A	<b>Output Low Voltage</b> I/O ports  OSC2/CLKOUT (RC osc config)	V <sub>OL</sub>	- - - -	- - - -	0.6 0.6 0.6 0.6	V V V V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C

\* These parameters are characterized but not tested.

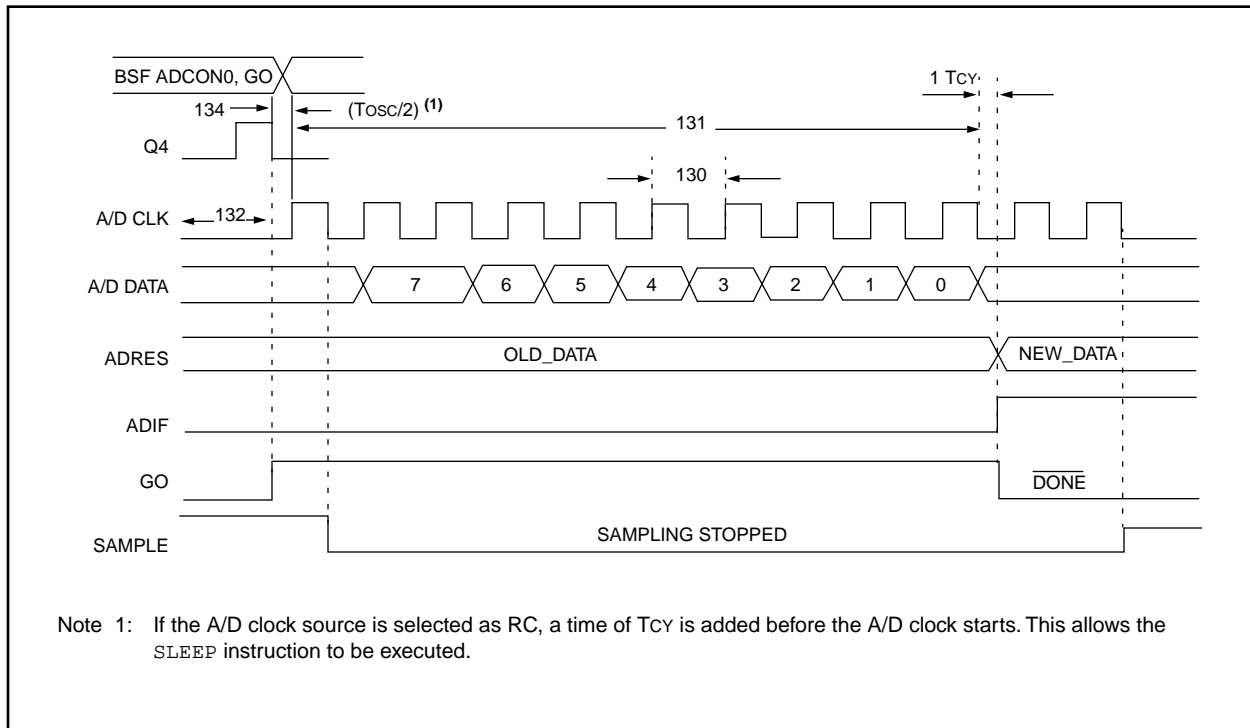
† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C7X be driven with external clock in RC mode.
- 2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3: Negative current is defined as current sourced by the pin.

# PIC16C7X

Applicable Devices 72 73 73A 74 74A 76 77

**FIGURE 19-14: A/D CONVERSION TIMING**



**TABLE 19-14: A/D CONVERSION REQUIREMENTS**

Param No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
130	TAD	A/D clock period	PIC16C73A/74A	1.6	—	—	μs	TOSC based, VREF ≥ 3.0V
			PIC16LC73A/74A	2.0	—	—	μs	TOSC based, VREF full range
			PIC16C73A/74A	2.0	4.0	6.0	μs	A/D RC Mode
			PIC16LC73A/74A	3.0	6.0	9.0	μs	A/D RC Mode
131	Tcnv	Conversion time (not including S/H time) (Note 1)		—	9.5	—	TAD	
132	TACQ	Acquisition time		Note 2	20	—	μs	The minimum time is the amplifier settling time. This may be used if the "new" input voltage has not changed by more than 1 LSb (i.e., 20.0 mV @ 5.12V) from the last sampled voltage (as stated on CHOLD).
				5*	—	—	μs	
134	Tgo	Q4 to A/D clock start		—	Tosc/2 §	—	—	If the A/D clock source is selected as RC, a time of Tcy is added before the A/D clock starts. This allows the SLEEP instruction to be executed.
135	Tswc	Switching from convert → sample time		1.5 §	—	—	TAD	

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

Note 1: ADRES register may be read on the following Tcy cycle.

2: See Section 13.1 for min conditions.

# PIC16C7X

Applicable Devices 72 73 73A 74 74A 76 77

## 20.5 Timing Diagrams and Specifications

FIGURE 20-2: EXTERNAL CLOCK TIMING

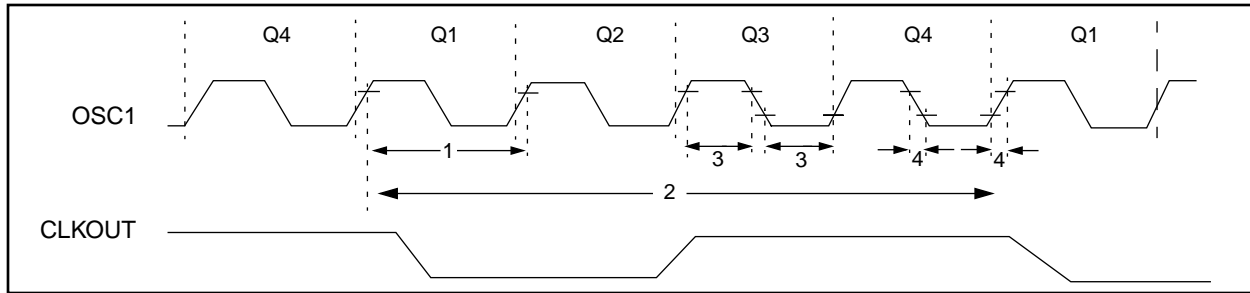


TABLE 20-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	Fosc	<b>External CLKIN Frequency (Note 1)</b>	DC	—	4	MHz	XT and RC osc mode
			DC	—	4	MHz	HS osc mode (-04)
			DC	—	10	MHz	HS osc mode (-10)
			DC	—	20	MHz	HS osc mode (-20)
			DC	—	200	kHz	LP osc mode
		<b>Oscillator Frequency (Note 1)</b>	DC	—	4	MHz	RC osc mode
			0.1	—	4	MHz	XT osc mode
			4	—	20	MHz	HS osc mode
			5	—	200	kHz	LP osc mode
	1	<b>External CLKIN Period (Note 1)</b>	250	—	—	ns	XT and RC osc mode
			250	—	—	ns	HS osc mode (-04)
			100	—	—	ns	HS osc mode (-10)
			50	—	—	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
		<b>Oscillator Period (Note 1)</b>	250	—	—	ns	RC osc mode
			250	—	10,000	ns	XT osc mode
			250	—	250	ns	HS osc mode (-04)
			100	—	250	ns	HS osc mode (-10)
			50	—	250	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
2	Tcy	<b>Instruction Cycle Time (Note 1)</b>	200	Tcy	DC	ns	Tcy = 4/Fosc
3	TosL, TosH	<b>External Clock in (OSC1) High or Low Time</b>	100	—	—	ns	XT oscillator
			2.5	—	—	μs	LP oscillator
			15	—	—	ns	HS oscillator
4	TosR, TosF	<b>External Clock in (OSC1) Rise or Fall Time</b>	—	—	25	ns	XT oscillator
			—	—	50	ns	LP oscillator
			—	—	15	ns	HS oscillator

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (Tcy) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.



## APPENDIX E: PIC16/17 MICROCONTROLLERS

### E.1 PIC12CXXX Family of Devices

		PIC12C508	PIC12C509	PIC12C671	PIC12C672
<b>Clock</b>	Maximum Frequency of Operation (MHz)	4	4	4	4
<b>Memory</b>	EPROM Program Memory	512 x 12	1024 x 12	1024 x 14	2048 x 14
	Data Memory (bytes)	25	41	128	128
<b>Peripherals</b>	Timer Module(s)	TMR0	TMR0	TMR0	TMR0
	A/D Converter (8-bit) Channels	—	—	4	4
<b>Features</b>	Wake-up from SLEEP on pin change	Yes	Yes	Yes	Yes
	I/O Pins	5	5	5	5
	Input Pins	1	1	1	1
	Internal Pull-ups	Yes	Yes	Yes	Yes
	Voltage Range (Volts)	2.5-5.5	2.5-5.5	2.5-5.5	2.5-5.5
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes
	Number of Instructions	33	33	35	35
	Packages	8-pin DIP, SOIC	8-pin DIP, SOIC	8-pin DIP, SOIC	8-pin DIP, SOIC

All PIC12C5XX devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability.  
All PIC12C5XX devices use serial programming with data pin GP1 and clock pin GP0.

### E.2 PIC14C000 Family of Devices

		PIC14C000
<b>Clock</b>	Maximum Frequency of Operation (MHz)	20
<b>Memory</b>	EPROM Program Memory (x14 words)	4K
	Data Memory (bytes)	192
	Timer Module(s)	TMR0 ADTMR
<b>Peripherals</b>	Serial Port(s) (SPI/I <sup>2</sup> C, USART)	I <sup>2</sup> C with SMBus Support
<b>Features</b>	Slope A/D Converter Channels	8 External; 6 Internal
	Interrupt Sources	11
	I/O Pins	22
	Voltage Range (Volts)	2.7-6.0
	In-Circuit Serial Programming	Yes
	Additional On-chip Features	Internal 4MHz Oscillator, Bandgap Reference, Temperature Sensor, Calibration Factors, Low Voltage Detector, SLEEP, HIBERNATE, Comparators with Programmable References (2)
	Packages	28-pin DIP (.300 mil), SOIC, SSOP